

### BFG135A

### NPN Silicon RF Transistor\*

- For low-distortion broadband output amplifier stages in antenna and telecommunication systems up to 2 GHz at collector currents from 70 mA to 130 mA
- Power amplifiers for DECT and PCN systems
- Integrated emitter ballast resistor
- $f_{\rm T} = 6 \, \rm GHz$
- Pb-free (RoHS compliant) package<sup>1)</sup>
- Qualified according AEC Q101
- \* Short term description



ESD (Electrostatic discharge) sensitive device, observe handling precaution!

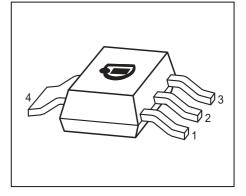
Туре	Marking	Pin Configuration					Package	
BFG135A	BFG135A	1=E	2=B	3=E	4=C	-	-	SOT223

#### **Maximum Ratings**

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V <sub>CEO</sub>	15	V
Collector-emitter voltage	V <sub>CES</sub>	25	
Collector-base voltage	V <sub>CBO</sub>	25	
Emitter-base voltage	V <sub>EBO</sub>	2	
Collector current	I <sub>C</sub>	150	mA
Base current	/ <sub>B</sub>	20	
Total power dissipation <sup>2)</sup>	P <sub>tot</sub>	1	W
<i>T</i> <sub>S</sub> ≤ 100°C			
Junction temperature	T <sub>i</sub>	150	°C
Ambient temperature	T <sub>A</sub>	-65 150	
Storage temperature	T <sub>stq</sub>	-65 150	

<sup>1</sup>Pb-containing package may be available upon special request

 ${}^{2}T_{S}$  is measured on the collector lead at the soldering point to the pcb





#### **Thermal Resistance**

Parameter	Symbol	Value	Unit
Junction - soldering point <sup>1)</sup>	R <sub>thJS</sub>	≤ 50	K/W

## **Electrical Characteristics** at $T_A = 25^{\circ}$ C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	]
DC Characteristics				•	•
Collector-emitter breakdown voltage	V <sub>(BR)CEO</sub>	15	-	-	V
$I_{\rm C} = 1  {\rm mA},  I_{\rm B} = 0$					
Collector-emitter cutoff current	I <sub>CES</sub>	-	-	100	μA
$V_{\rm CE} = 25 \text{ V}, \ V_{\rm BE} = 0$					
Collector-base cutoff current	I <sub>CBO</sub>	-	-	50	nA
$V_{\rm CB} = 10 \text{ V}, I_{\rm E} = 0$					
Emitter-base cutoff current	I <sub>EBO</sub>	-	-	1	μA
$V_{\rm EB} = 1  \rm V,  I_{\rm C} = 0$					
DC current gain-	h <sub>FE</sub>	80	120	160	-
$I_{\rm C}$ = 100 mA, $V_{\rm CE}$ = 8 V, pulse measured					

<sup>1</sup>For calculation of  $R_{\rm thJA}$  please refer to Application Note Thermal Resistance



Parameter	Symbol		Unit		
		min.	typ.	max.	
AC Characteristics (verified by random samplin	g)		1	1	
Transition frequency	f <sub>T</sub>	4.5	6	-	GHz
$I_{\rm C}$ = 100 mA, $V_{\rm CE}$ = 8 V, $f$ = 200 MHz					
Collector-base capacitance	C <sub>cb</sub>	-	1.1	1.5	pF
$V_{\rm CB} = 10 \text{ V}, f = 1 \text{ MHz}, V_{\rm BE} = 0$ ,					
emitter grounded					
Collector emitter capacitance	C <sub>ce</sub>	-	0.8	-	]
$V_{CE} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$ ,					
base grounded					
Emitter-base capacitance	C <sub>eb</sub>	-	7	-	]
$V_{\rm EB} = 0.5 \text{ V}, f = 1 \text{ MHz}, V_{\rm CB} = 0$ ,					
collector grounded					
Noise figure	F				dB
$I_{\rm C} = 30 \text{ mA}, V_{\rm CE} = 8 \text{ V}, Z_{\rm S} = Z_{\rm Sopt},$					
<i>f</i> = 900 MHz		-	1.5	-	
<i>f</i> = 1.8 GHz		-	2.6	-	
Power gain, maximum available <sup>1)</sup>	G <sub>ma</sub>				]
$I_{\rm C}$ = 100 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$ , $Z_{\rm L}$ = $Z_{\rm Lopt}$ ,					
<i>f</i> = 900 MHz		-	14	-	
<i>f</i> = 1.8 GHz		-	9	-	
Transducer gain	S <sub>21e</sub>   <sup>2</sup>				dB
$I_{\rm C}$ = 100 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 $\Omega$ ,					
<i>f</i> = 900 MHz		-	10.5	-	
<i>f</i> = 1.8 GHz		-	4.5	-	
Third order intercept point at output	IP <sub>3</sub>	-	33	-	dBm
V <sub>CE</sub> = 8 V, <i>I</i> <sub>C</sub> = 100 mA, <i>f</i> = 900 MHz,					
$Z_{\rm S} = Z_{\rm L} = 50\Omega$					

# **Electrical Characteristics** at $T_A = 25^{\circ}$ C, unless otherwise specified

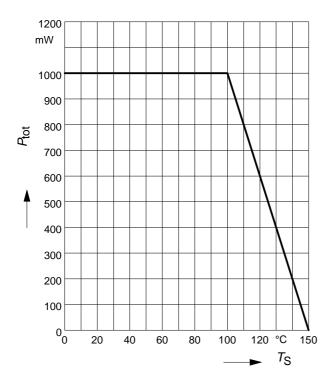
 ${}^{1}\mathrm{G}_{\mathrm{ma}} = |\mathrm{S}_{21}/\mathrm{S}_{12}| \; (\mathrm{k}\text{-}(\mathrm{k}^{2}\text{-}1)^{1/2})$ 



BFG135A

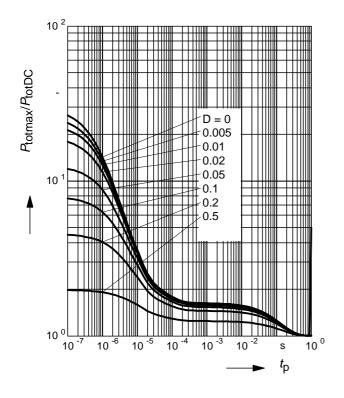
# Total power dissipation $P_{tot} = f(T_S)$

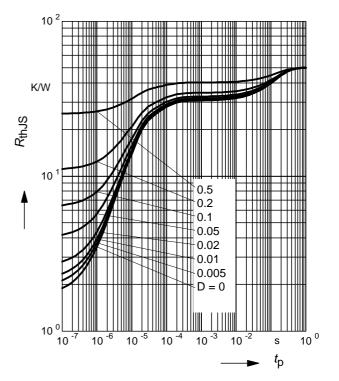
Permissible Pulse Load  $R_{\text{thJS}} = f(t_{\text{p}})$ 



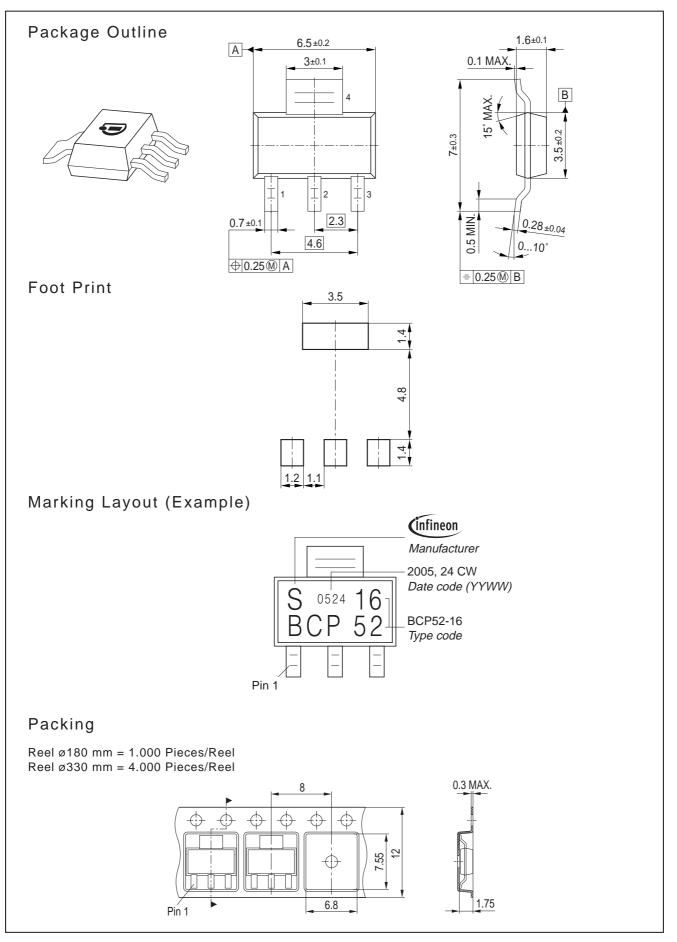
### Permissible Pulse Load

 $P_{\text{totmax}}/P_{\text{totDC}} = f(t_{p})$ 











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